



PATENT NO. 6,780,707 Attorney's Doc. No. 9898-201

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent No.:

6,780,707

Inventor:

Lee

Issued:

August 24, 2004

For:

METHOD OF FORMING SEMICONDUCTOR DEVICE HAVING CONTACT

PAD ON SOURCE/DRAIN REGION IN PERIPHERAL CIRCUIT AREA

Ser. No.:

10/043,724

Filed:

January 8, 2002

Group Art Unit:

2823

Examiner:

Hsien Ming Lee

## REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Upon comparison of the above-identified original Letters Patent with applicant's copy of the application therefor, the following errors in the original Letters Patent have been noted:

Column 7, line 5, "this-process" should read --this process--.

Column 9, line 14, "340' and" should read --340', and--.

Column 9, line 18, "340' and" should read --340', and--.

Column 10, line 19, "layers EN, which" should read --layers E<sub>N</sub>, which--.

Column 10, line 31, "layers EN on" should read --layers E<sub>N</sub> on--.

Column 13, line 30, "layer; and (g) forming" should read --layer; (g) forming--.

Column 13, line 31, "forming second" should read --forming a second--.

Column 13, line 44, "wherein (e) comprises" should read --wherein (h) comprises--.

Column 13, line 50, "wherein in (e) comprises" should read --wherein (h) comprises--.

Column 13, line 51, "polishing the conductive material and the" should read --polishing the first and second conductive type polysilicon layers and the--.

Column 14, line 19, "by farming a" should read --by forming a--.

Column 14, line 26, "of claim wherein" should read --of claim 8, wherein--.

Column 14, line 32, "the plugs" should read --the metal plugs--.

Column 14, line 51, "opening, and" should read --opening; and--.

Column 15, line 15, "opening the" should read --opening, the--.

Column 15, line 22, "device inducting a" should read --device including a--.

Column 15, line 43, "circuit axes, and" should read --circuit area, and--.

Request for Certificate of Correction Patent No. 6,780,707 April 12, 2005 Page two

Applicant respectfully requests that a Certificate of Correction calling attention to the above errors be issued pursuant to Rule 322 of the Patent Office and Title 35, United States Code, Section 254. Two copies of a Certificate of Correction form are enclosed.

Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Hosoon Lee

Limited Recognition Under 37 CFR § 10.9(b)

MARGER JOHNSON & McCOLLOM, P.C. 1030 SW Morrison Street Portland, OR 97205 503-222-3613

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Date: April 12, 2005

Susan K. Kral

(Also Form PTO-1050)

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INVENTOR(S):

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MAILING ADDRESS OF SENDER: Marger Johnson & McCollom 1030 S.W. Morrison Street Portland, Oregon 97205 PATENT NO. 6,780,707

No. of additional copies

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# BEFORE THE OFFICE OF ENROLLMENT AND DISCIPLINE UNITED STATES PATENT AND TRADEMARK OFFICE

### LIMITED RECOGNITION UNDER 37 CFR § 10.9(b)

Hosoon Lee is hereby given limited recognition under 37 CFR § 10.9(b), as an employee of the law firm of Marger Johnson & McCollom, PC, to prepare and prosecute patent applications wherein the patent applicant is a client of the law firm of Marger Johnson & McCollom, PC, and a registered practitioner, who is a member of the law firm of Marger Johnson & McCollom, PC, is the practitioner of record in the application. This limited recognition shall expire on the date appearing below, or when whichever of the following events first occurs prior to the date appearing below: (i) Hosoon Lee ceases to lawfully reside in the United States, (ii) Hosoon Lee's employment with the law firm of Marger Johnson & McCollom, PC, ceases or is terminated, or (iii) Hosoon Lee ceases to remain or reside in the United States, authorized to be employed by an Employment Authorization Card issued pursuant to 8 CFR § 274a.12(c)(9).

This document constitutes proof of such limited recognition. The original of this document is on file in the Office of Enrollment and Discipline of the U.S. Patent and Trademark Office.

**Expires: July 16, 2005** 

Harry I. Moatz

Director of Enrollment and Discipline



## PATENT APPLICATION Attorney's Doc. No. 9898-201

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Enclosed for filing are the following:

Request for Certificate of Correction

Certificate of Correction Form PTO 1050

A copy of the Limited Recognition Under 37 CFR § 10.9(b) form

Return postcard

Any deficiency or overpayment should be charged or credited to deposit account

number 13-1703.

Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Hosoon Lee

Limited Recognition Under 37 CFR § 10.9(b)

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Customer No. 20575

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Date: April 12, 2005

Susan K Kral